



Description

The IRF7416T uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.



SOP-8

$V_{DS} = -30V$ $I_D = -11A$

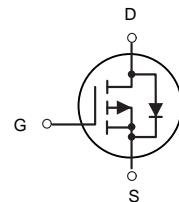
$R_{DS(ON)} < 16m\Omega$ @ $V_{GS}=10V$

Application

Battery protection

Load switch

Uninterruptible power supply



P-Channel MOSFET

Package Marking and Ordering Information

| Product ID | Pack | Marking | Qty(PCS) |
|------------|-------|--------------|----------|
| IRF7416T | SOP-8 | 4435 XXX YYY | 3000 |

Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise noted)

| Symbol | Parameter | Rating | Units |
|----------------------|---|------------|--------------|
| V_{DS} | Drain-Source Voltage | - 30 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| $I_D@T_A=25^\circ C$ | Drain Current ³ , $V_{GS} @ 10V$ | -11 | A |
| IDM | Pulsed Drain Current ¹ | -40 | A |
| $P_D@T_A=25^\circ C$ | Total Power Dissipation | 3.7 | W |
| T_{STG} | Storage Temperature Range | -55 to 150 | $^\circ C$ |
| T_J | Operating Junction Temperature Range | -55 to 150 | $^\circ C$ |
| R_{thj-a} | Maximum Thermal Resistance, Junction-ambient ³ | 33.8 | $^\circ C/W$ |



Electrical Characteristics ($T_J = 25^\circ\text{C}$, unless otherwise noted)

| Symbol | Parameter | Test Condition | Min. | Typ. | Max. | Units |
|---|--|---|------|------|-----------|------------------|
| Off Characteristic | | | | | | |
| $V_{(\text{BR})\text{DSS}}$ | Drain-Source Breakdown Voltage | $V_{GS}=0\text{V}$, $I_D = -250\mu\text{A}$ | -30 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = -30\text{V}$, $V_{GS}=0\text{V}$, | - | - | -1 | μA |
| I_{GSS} | Gate to Body Leakage Current | $V_{DS}=0\text{V}$, $V_{GS} = \pm 20\text{V}$ | - | - | ± 100 | nA |
| On Characteristics | | | | | | |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}$, $I_D = -250\mu\text{A}$ | -1.0 | -1.6 | -2.5 | V |
| $R_{DS(\text{on})}$ | Static Drain-Source on-Resistance Note3 | $V_{GS} = -10\text{V}$, $I_D = -10\text{A}$ | - | 13 | 16 | $\text{m}\Omega$ |
| | | $V_{GS} = -4.5\text{V}$, $I_D = -5\text{A}$ | - | 18 | 27 | |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS} = -15\text{V}$, $V_{GS}=0\text{V}$, $f=1.0\text{MHz}$ | - | 1330 | - | pF |
| C_{oss} | Output Capacitance | | - | 183 | - | pF |
| C_{rss} | Reverse Transfer Capacitance | | - | 156 | - | pF |
| Q_g | Total Gate Charge | $V_{DS} = -15\text{V}$, $I_D = -5\text{A}$, $V_{GS} = -10\text{V}$ | - | 22 | - | nC |
| Q_{gs} | Gate-Source Charge | | - | 1.0 | - | nC |
| Q_{gd} | Gate-Drain("Miller") Charge | | - | 1.8 | - | nC |
| Switching Characteristics | | | | | | |
| $t_{d(on)}$ | Turn-on Delay Time | $V_{DD} = -15\text{V}$, $I_D = -10\text{A}$, $V_{GS} = -10\text{V}$, $R_{GEN} = 2.5\Omega$ | - | 9 | - | ns |
| t_r | Turn-on Rise Time | | - | 13 | - | ns |
| $t_{d(off)}$ | Turn-off Delay Time | | - | 48 | - | ns |
| t_f | Turn-off Fall Time | | - | 20 | - | ns |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| I_S | Maximum Continuous Drain to Source Diode Forward Current | - | - | -11 | - | A |
| I_{SM} | Maximum Pulsed Drain to Source Diode Forward Current | - | - | -40 | - | A |
| V_{SD} | Drain to Source Diode Forward Voltage | $V_{GS}=0\text{V}$, $I_S = -15\text{A}$ | - | -0.8 | -1.2 | V |
| trr | Reverse Recovery Time | $T_J=25^\circ\text{C}$, $V_{DD} = -24\text{V}$, $I_F = -2.8\text{A}$, $dI/dt = -100\text{A}/\mu\text{s}$ | - | 64 | - | ns |
| Qrr | Reverse Recovery Charge | | - | 25 | - | nC |

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. EAS condition: $T_J=25^\circ\text{C}$, $V_{GS}=10\text{V}$, $R_G=25\Omega$, $L=0.5\text{mH}$, $I_{AS}=-12.7\text{A}$

3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$



Typical Characteristics

Figure 1: Output Characteristics

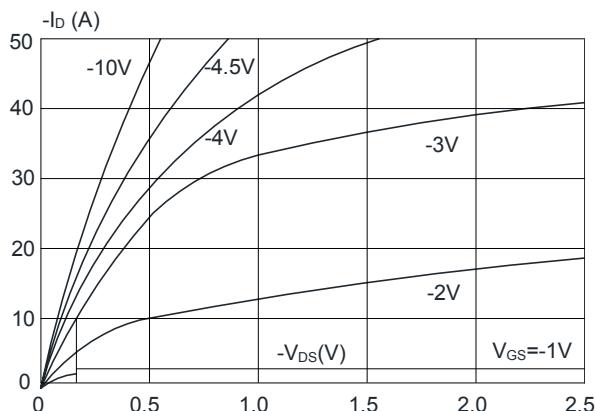


Figure 3: On-resistance vs. Drain Current

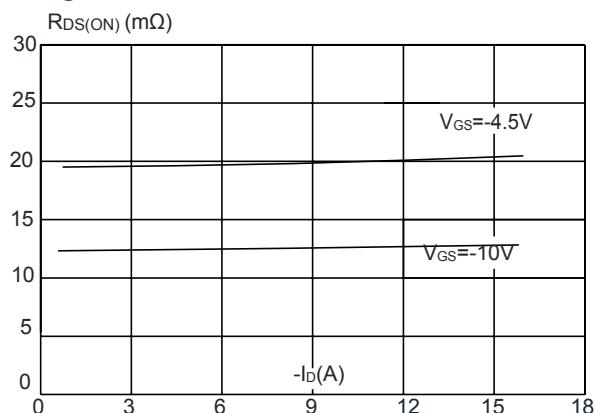


Figure 5: Gate Charge Characteristics

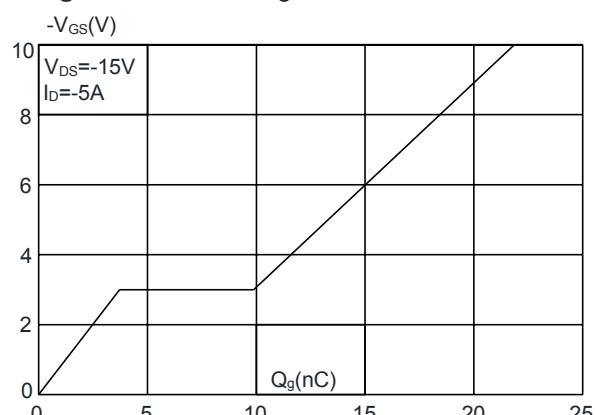


Figure 2: Typical Transfer Characteristics

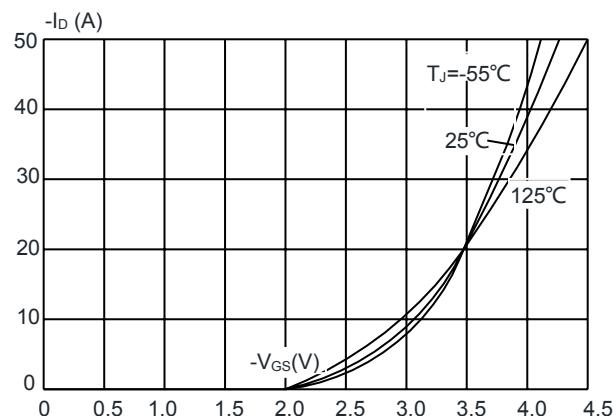


Figure 4: Body Diode Characteristics

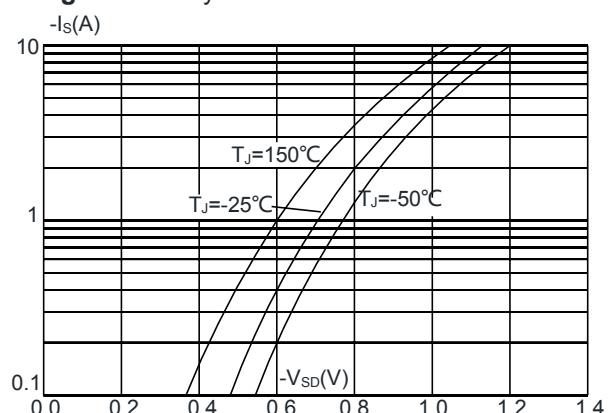


Figure 6: Capacitance Characteristics

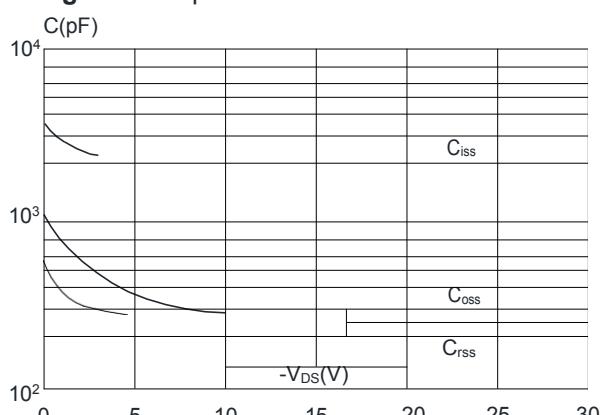




Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

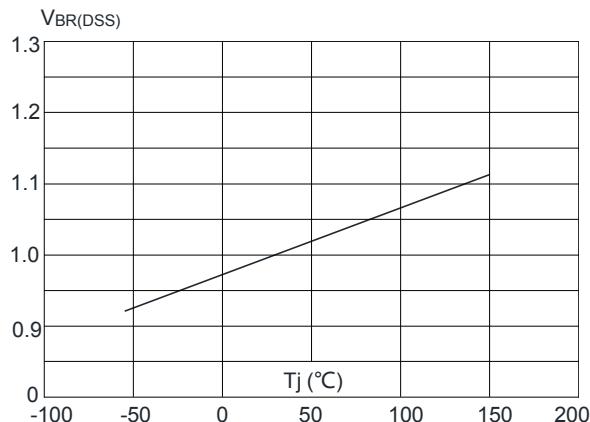


Figure 9: Maximum Safe Operating Area

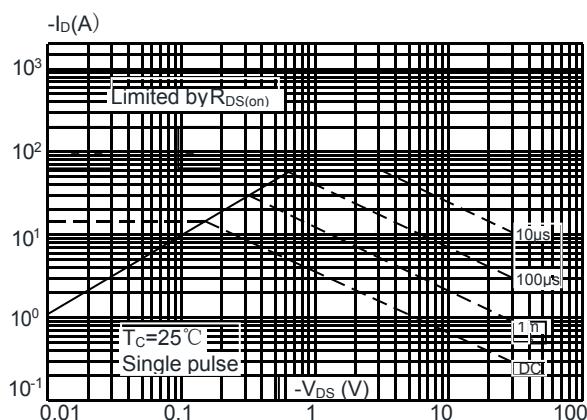


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

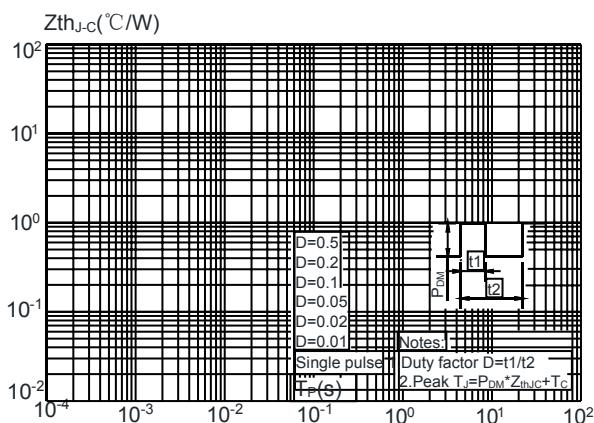


Figure 8: Normalized on Resistance vs. Junction Temperature

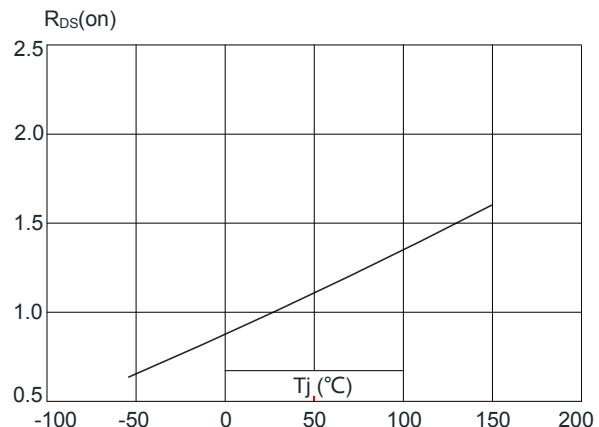
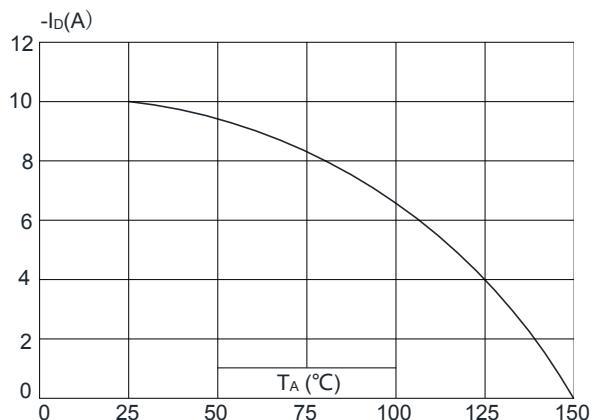


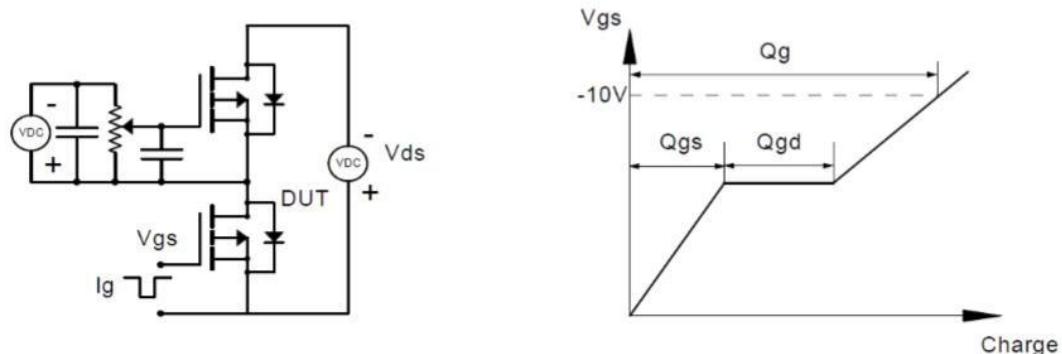
Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature



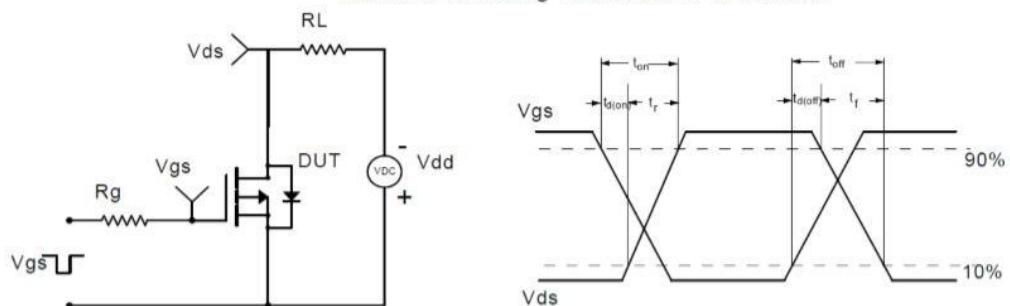


Test Circuit

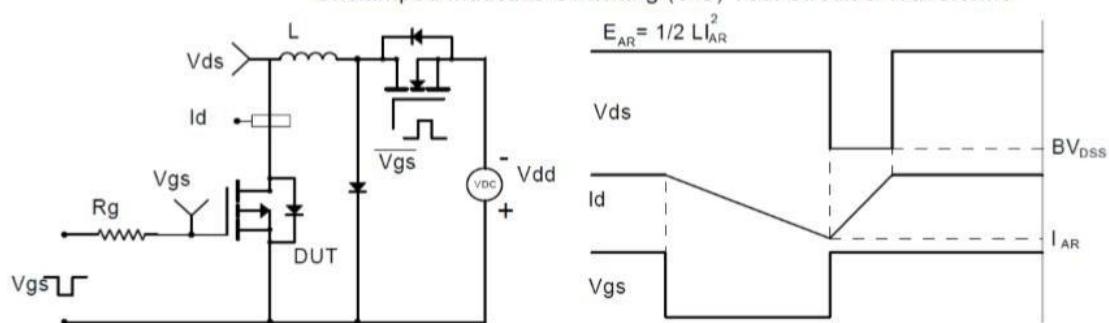
Gate Charge Test Circuit & Waveform



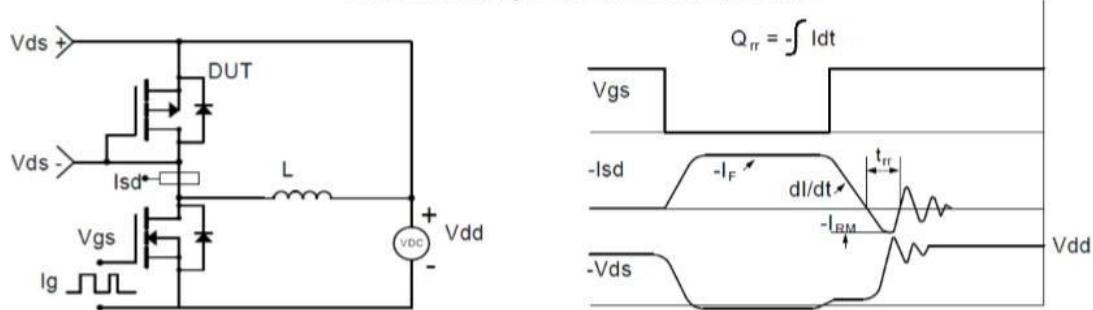
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

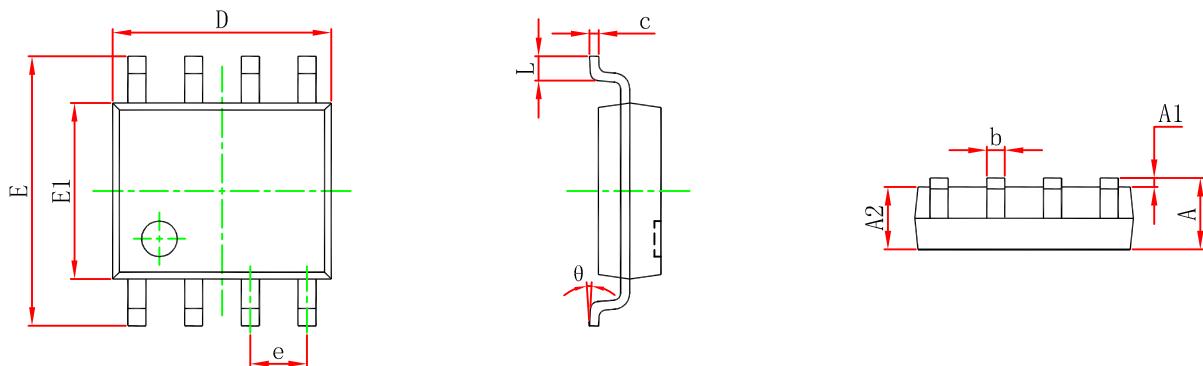


Diode Recovery Test Circuit & Waveforms

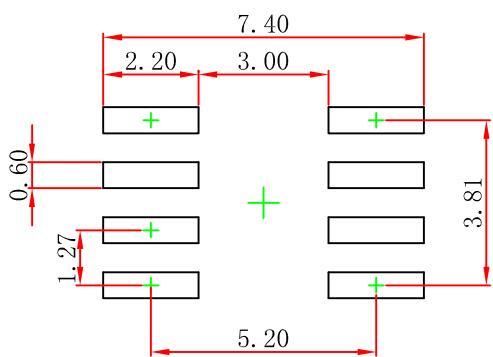




SOP-8 Package Outline Dimensions



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 1.350 | 1.750 | 0.053 | 0.069 |
| A1 | 0.100 | 0.250 | 0.004 | 0.010 |
| A2 | 1.350 | 1.550 | 0.053 | 0.061 |
| b | 0.330 | 0.510 | 0.013 | 0.020 |
| c | 0.170 | 0.250 | 0.007 | 0.010 |
| D | 4.800 | 5.000 | 0.189 | 0.197 |
| e | 1.270 (BSC) | | 0.050 (BSC) | |
| E | 5.800 | 6.200 | 0.228 | 0.244 |
| E1 | 3.800 | 4.000 | 0.150 | 0.157 |
| L | 0.400 | 1.270 | 0.016 | 0.050 |
| θ | 0° | | 8° | |



Note:
1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.



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